

PATENT ASSIGNMENT

Electronic Version v1.1
 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
GENG-SHIN SHEN	02/12/2008
Yu-Ren CHEN	02/12/2008
RECEIVING PARTY DATA	
Name:	CHIPMOS TECHNOLOGIES INC
Street Address:	No.1. R&D Rd.1, Science-Based Industrial Park
City:	Hsinchu
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12134336
CORRESPONDENCE DATA	
Fax Number:	(206)203-2603
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	301-315-5807
Email:	MCHOW@SINORICA.COM
Correspondent Name:	SINORICA, LLC
Address Line 1:	528 FALLSGROVE DRIVE
Address Line 4:	ROCKVILLE, MARYLAND 20850
ATTORNEY DOCKET NUMBER:	TW-GNA-0679
NAME OF SUBMITTER:	Ming Chow
Total Attachments: 2 source=assignment_B006807053#page1.tif source=assignment_B006807053#page2.tif	

OP \$40.00 12134336

ASSIGNMENT DEED

This assignment agreement is applicable to an invention entitled (invention title) _____

Method for Fabricating Multi-Chip Stacked Package

This PATENT RIGHT referred to in this agreement is (check one):

- a Patent Application for this invention, executed by the ASSIGNOR(S) concurrently with this Agreement.
 U.S. Patent Application Serial No. _____, filed on _____
 U.S. patent No. _____, issued on _____

The PATENT RIGHT assigned under this agreement is:

- U.S. Patent rights only
 worldwide Patent rights (the assignee shall have the right to claim the benefit for the filing date of any U.S. Patent Application identified above).

The ASSIGNOR(S) referred to in this agreement is (or are):

SHEN,GENG-SHIN (full name of first assignor)
No.1. R&D Rd.1, Science-Based Industrial Park, Hsinchu city, Taiwan, (R.O.C.) (address)

The ASSIGNOR(S) referred to in this agreement is (or are):

Chen, Yu-Ren (full name of second assignor)
No.1. R&D Rd.1, Science-Based Industrial Park, Hsinchu city, Taiwan, (R.O.C.) (address)

The first ASSIGNEE referred to in this agreement is:

CHIPMOS TECHNOLOGIES INC (full name of first assignee)
No.1. R&D Rd.1, Science-Based Industrial Park, Hsinchu city, Taiwan, R.O.C. (address)

Is (check one): [] an individual [] a partnership [x] a Corporation of Taiwan, (R.O.C.) (State or Country)

The second ASSIGNEE referred to in this agreement is:

CHIPMOS TECHNOLOGIES (BERMUDA) LTD (full name of first assignee)
Canon's Court, 22 Victoria Street, Hamilton HM 12, Bermuda (address)

Is (check one): [] an individual [] a partnership [x] a Corporation of Bermuda (State or Country)

The ASSIGNOR(S), in consideration of \$1.00 paid by the ASSIGNEE, and other good and valuable consideration, receipt of which is acknowledged, have and do hereby assign the following to each ASSIGNEE, their successors and assigns:

- the full and exclusive right to the invention;
an equal interest in and to the entire right, title and interest in and to the PATENT RIGHTS in the invention;
all continuations, continuations-in-part, divisionals, re-issues, and re-examination patents and patent applications; and
the right to claim priority under 35 U.S.C. 119, based on any earlier foreign applications for this invention.

